

PATENT ASSIGNMENT

Electronic Version v1.1

Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT	
NATURE OF CONVEYANCE:	ASSIGNMENT	
CONVEYING PARTY DATA		
Name		Execution Date
SUN SUK YANG		05/10/2007
RECEIVING PARTY DATA		
Name:	HYNIX SEMICONDUCTOR INC.	
Street Address:	San 136-1, Ami-ri, Bubal-eub, Icheon-si	
City:	Kyoungki-do	
State/Country:	KOREA, REPUBLIC OF	
PROPERTY NUMBERS Total: 1		
Property Type	Number	
Application Number:	11683532	
CORRESPONDENCE DATA		
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Address Line 1:	LADAS & PARRY, 224 SOUTH MICHIGAN AVE.	
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ATTORNEY DOCKET NUMBER:	CU-5471 WWP/NK	
NAME OF SUBMITTER:	Woochoon W. Park	
Total Attachments: 2		
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source=cu5471assign#page2.tif		

CH \$40.00 11683532

UNITED STATES OF AMERICA
ASSIGNMENT

In consideration of the payment of ASSIGNEE to ASSIGNOR of the sum of One Dollar (\$1.00), the receipt of which is hereby acknowledged, and for the other good and valuable consideration,

ASSIGNOR:

Name : Sun Suk YANG

Address : 306-1105, Mongnyeon Woosung Apt., 1052-3, Beomgye-dong, Dongan-gu,
Anyang-si, Kyongki-do, Korea

(INVENTOR NAME AND ADDRESS)

hereby sells, assigns and transfers to

ASSIGNEE:

Name : Hynix Semiconductor Inc.

Address : San 136-1, Ami-ri, Bubal-eub, Icheon-si, Kyongki-do, Korea

(ASSIGNEE NAME AND ADDRESS)

and the successors, assigns and legal representatives of the ASSIGNEE the entire right, title and interest for the United States and its territorial possessions in and to, any and all improvements which are disclosed in the invention entitled:

ADDRESS LATCH CIRCUIT OF SEMICONDUCTOR MEMORY DEVICE

(TITLE)

and which is found in *(check one applicable item below)*

☐ U.S. patent application executed on even date herewith

☒ U.S. Application Serial No. 11/683,532 filed on March 8, 2007

and, in and to all Letters Patent to be obtained for said invention by the above application or any continuation, division, renewal, substitute, reissue or re-examination thereof.

ASSIGNOR hereby covenants that no assignment, sale agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale;

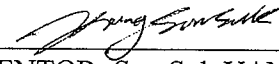
ASSIGNOR further covenants that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said invention and said Letters Patent and legal equivalents as may be known and accessible to ASSIGNOR and will testify as to the same in any interference or litigation related thereto and will promptly execute and

deliver to ASSIGNEE or its legal representatives any and all papers, instruments or affidavits required to apply for, obtain, maintain, issue and enforce said application, said invention and said Letters Patent and said equivalents thereof which may be necessary or desirable to carry out the purposes thereof.

IN WITNESS WHEREOF, I/we have set our hand and seal

May 10, 2007

Date


INVENTOR: Sun Suk YANG

Date

INVENTOR:

0699P/1